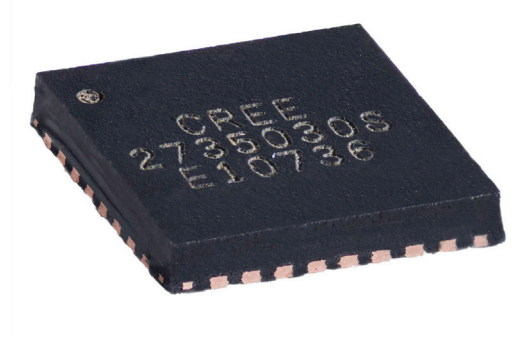


# CMPA2735030S

30 W, 2.7 - 3.5 GHz, GaN MMIC, Power Amplifier

## Description

Cree's CMPA2735030S is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage reactively matched amplifier design approach enabling high power and power added efficiency to be achieved in a 5mm x 5mm, surface mount (QFN package).



PN: CMPA2735030S  
Package: 5x5 mm

## Typical Performance Over 2.7 - 3.5 GHz ( $T_c = 25^\circ\text{C}$ )

Parameter	2.7 GHz	2.9 GHz	3.1 GHz	3.3 GHz	3.5 GHz	Units
Small Signal Gain	33.8	32.9	32.9	33.5	33.4	dB
Output Power <sup>1</sup>	36.5	39.7	40.6	36.0	27.8	W
Power Gain <sup>1</sup>	27.6	28.0	28.1	27.6	26.4	dB
PAE <sup>1</sup>	57	53	51	51	45	%

Note:

<sup>1</sup>  $P_{IN} = 18\text{ dBm}$ , Pulse Width = 100  $\mu\text{s}$ ; Duty Cycle = 10%

### Features

- 32 dB Small Signal Gain
- Operation up to 50 V
- High Breakdown Voltage
- High Temperature Operation
- 5 mm x 5 mm Total Product Size

### Applications

- Civil and Military Pulsed Radar Amplifiers

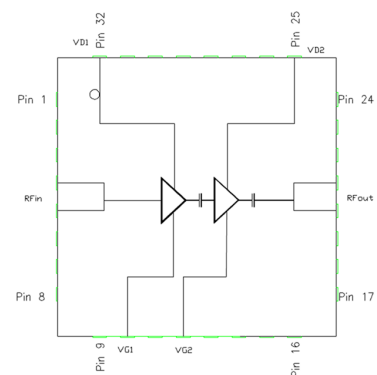


Figure 1.

**RoHS**  
COMPLIANT



**Absolute Maximum Ratings (not simultaneous) at 25 °C**

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	$V_{DSS}$	150	VDC	25°C
Gate-source Voltage	$V_{GS}$	-10, +2	VDC	25°C
Storage Temperature	$T_{STG}$	-65, +150	°C	
Maximum Forward Gate Current	$I_G$	15.5	mA	25°C
Soldering Temperature	$T_S$	260	°C	

**Electrical Characteristics (Frequency = 2.7 GHz to 3.5 GHz unless otherwise stated;  $T_c = 25 °C$ )**

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	-3.8	-3.0	-2.3	V	$V_{DS} = 10 V, I_D = 7.6 mA$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V <sub>DC</sub>	$V_{DD} = 50 V, I_{DQ} = 135 mA$
Saturated Drain Current <sup>1</sup>	$I_{DS}$	-	4.6	-	A	$V_{DS} = 6.0 V, V_{GS} = 2.0 V$
Drain-Source Breakdown Voltage	$V_{BD}$	-	150	-	V	$V_{GS} = -8 V, I_D = 7.6 mA$
<b>RF Characteristics<sup>2,3</sup></b>						
Small Signal Gain	$S21_1$	-	33.8	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 2.7 GHz$
Small Signal Gain	$S21_2$	-	32.9	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.1 GHz$
Small Signal Gain	$S21_3$	-	33.4	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.5 GHz$
Power Output	$P_{OUT1}$	-	36.5	-	W	$V_{DD} = 50 V, I_{DQ} = 135 mA, P_{IN} = 21 dBm, Freq = 2.7 GHz$
Power Output	$P_{OUT2}$	-	40.6	-	W	$V_{DD} = 50 V, I_{DQ} = 135 mA, P_{IN} = 21 dBm, Freq = 3.1 GHz$
Power Output	$P_{OUT3}$	-	27.8	-	W	$V_{DD} = 50 V, I_{DQ} = 135 mA, P_{IN} = 21 dBm, Freq = 3.5 GHz$
Power Added Efficiency	$PAE_1$	-	57	-	%	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 2.7 GHz$
Power Added Efficiency	$PAE_2$	-	51	-	%	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.1 GHz$
Power Added Efficiency	$PAE_3$	-	45	-	%	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.5 GHz$
Input Return Loss	$S11_1$	-	-18.2	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 2.7 GHz$
Input Return Loss	$S11_2$	-	-13.4	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.1 GHz$
Input Return Loss	$S11_3$	-	-27.0	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.5 GHz$
Output Return Loss	$S22_1$	-	-14.9	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 2.7 GHz$
Output Return Loss	$S22_2$	-	-9.5	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.1 GHz$
Output Return Loss	$S22_3$	-	-16.5	-	dB	$V_{DD} = 50 V, I_{DQ} = 135 mA, Freq = 3.5 GHz$
Output Mismatch Stress	VSWR	-	5:1	-	Ψ	No damage at all phase angles, $V_{DD} = 50 V, I_{DQ} = 135 mA, P_{IN} = 18 dBm$

Notes:

<sup>1</sup> Scaled from PCM data

<sup>2</sup> Measured in CMPA2735030S high volume test fixture at 2.7, 3.1 and 3.5 GHz and may not show the full capability of the device due to source inductance and thermal performance.

<sup>3</sup> Pulse Width = 25 μs; Duty Cycle = 1%

**Thermal Characteristics**

Parameter	Symbol	Rating	Units	Conditions
Operating Junction Temperature	$T_J$	225	°C	
Thermal Resistance, Junction to Case (packaged) <sup>1</sup>	$R_{JC}$	2.62	°C/W	Pulse Width = 500 μs, Duty Cycle = 10%

Notes:

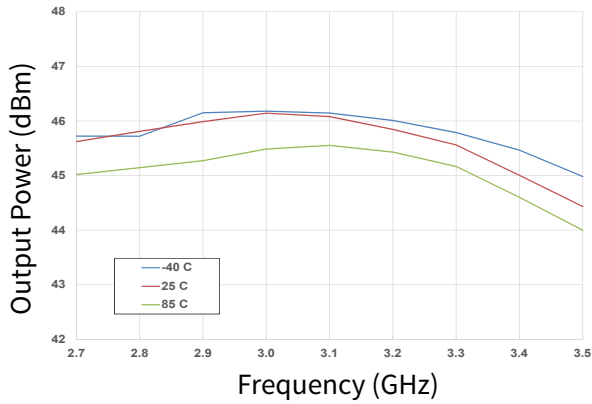
<sup>1</sup> Measured for the CMPA2735030S at  $P_{DISS} = 32 W$



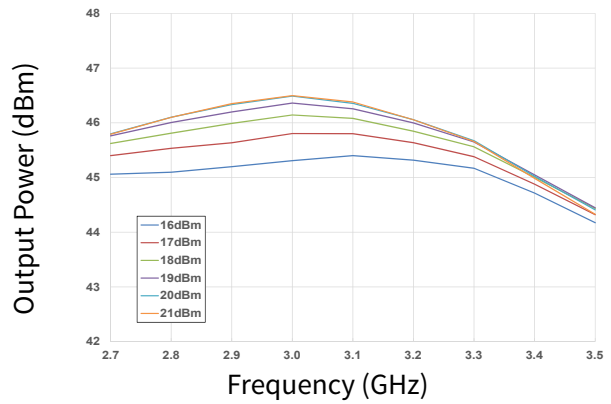
### Typical Performance of the CMPA2735030S

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $PW = 100\ \mu\text{s}$ ,  $DC = 10\%$ ,  $P_{in} = 18\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

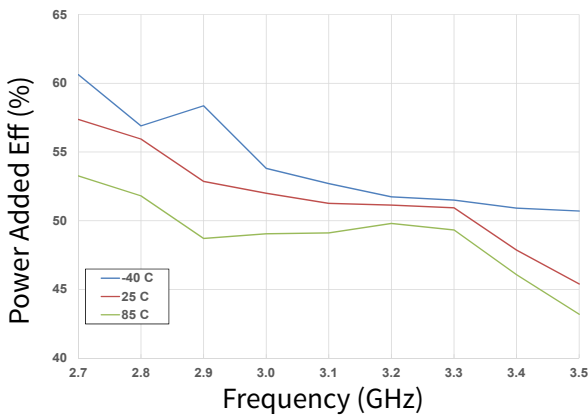
**Figure 1. Output Power vs Frequency as a Function of Temperature**



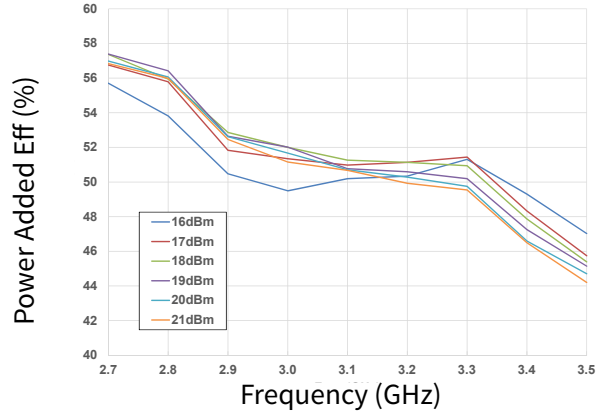
**Figure 2. Output Power vs Frequency as a Function of Input Power**



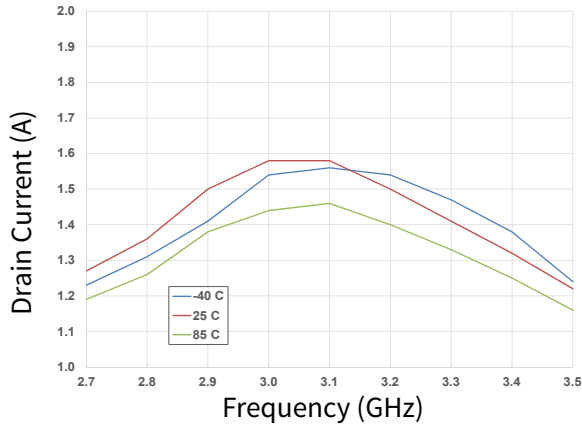
**Figure 3. Power Added Eff. vs Frequency as a Function of Temperature**



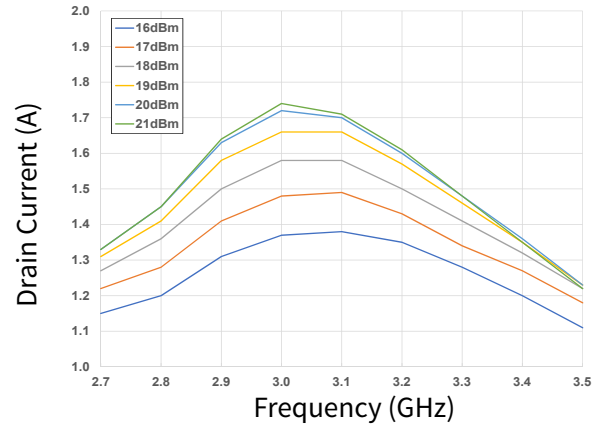
**Figure 4. Power Added Eff. vs Frequency as a Function of Input Power**



**Figure 5. Drain Current vs Frequency as a Function of Temperature**



**Figure 6. Drain Current vs Frequency as a Function of Input Power**

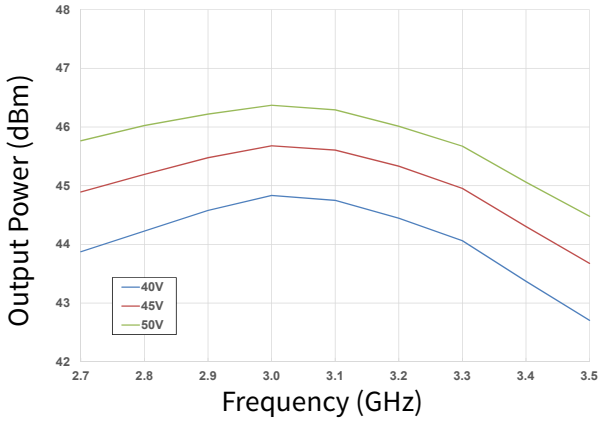




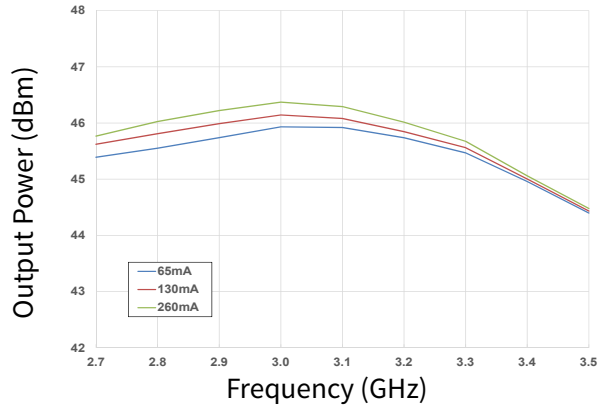
### Typical Performance of the CMPA2735030S

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $PW = 100\ \mu\text{s}$ ,  $DC = 10\%$ ,  $P_{in} = 18\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

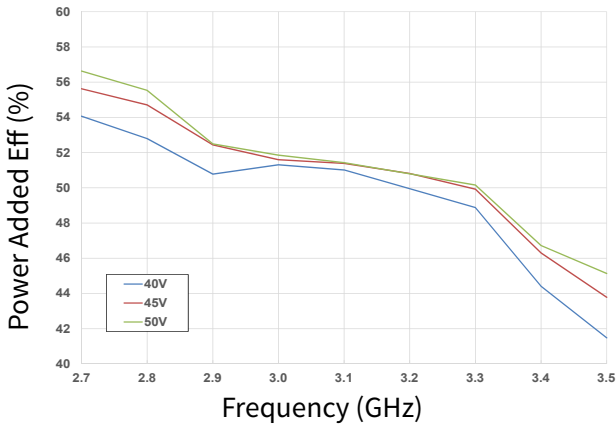
**Figure 7. Output Power vs Frequency as a Function of  $V_D$**



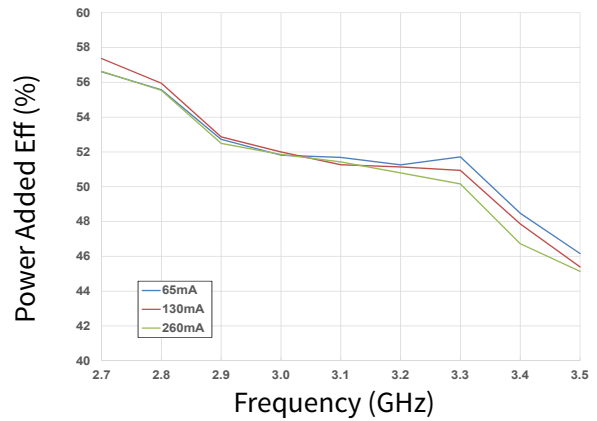
**Figure 8. Output Power vs Frequency as a Function of  $I_{DQ}$**



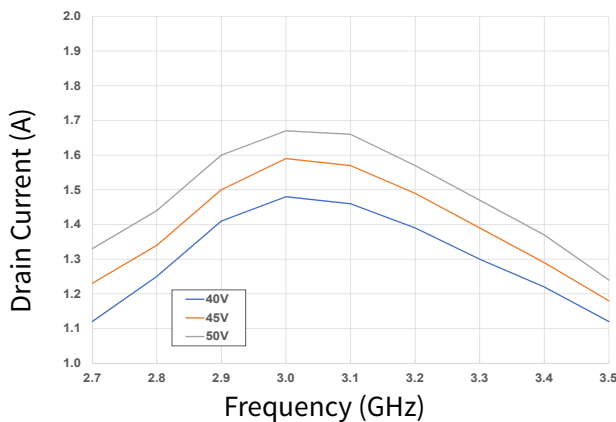
**Figure 9. Power Added Eff. vs Frequency as a Function of  $V_D$**



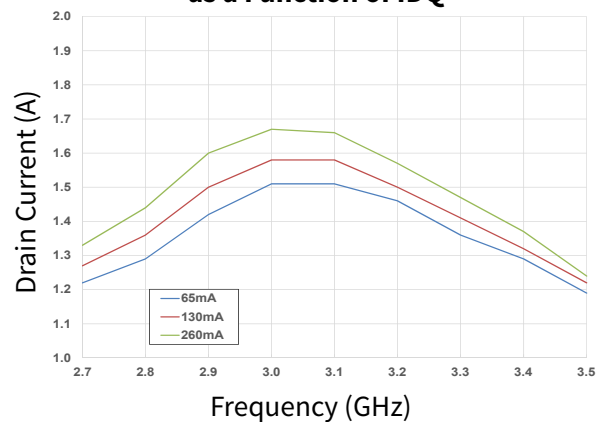
**Figure 10. Power Added Eff. vs Frequency as a Function of  $I_{DQ}$**



**Figure 11. Drain Current vs Frequency as a Function of  $V_D$**



**Figure 12. Drain Current vs Frequency as a Function of  $I_{DQ}$**

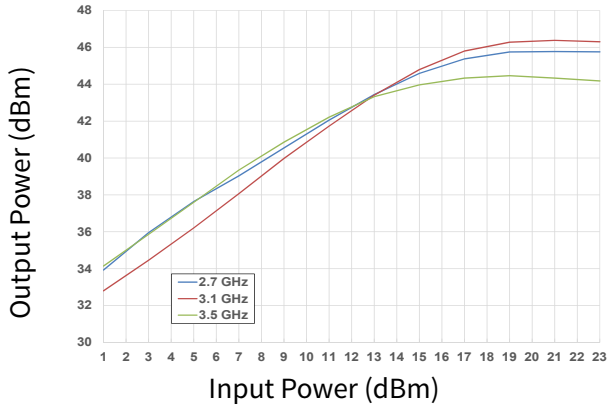




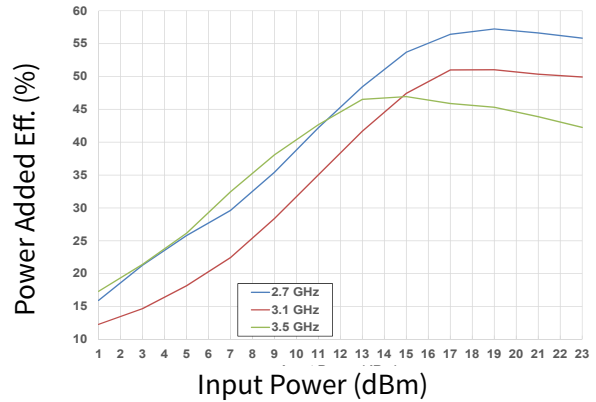
### Typical Performance of the CMPA2735030S

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $PW = 100\text{ }\mu\text{s}$ ,  $DC = 10\%$ ,  $P_{in} = 18\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

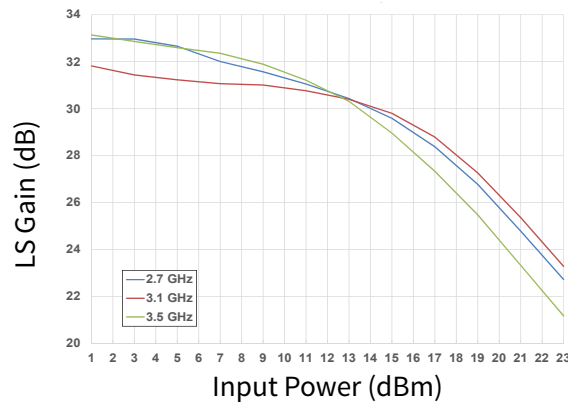
**Figure 13. Output Power vs Input Power as a Function of Frequency**



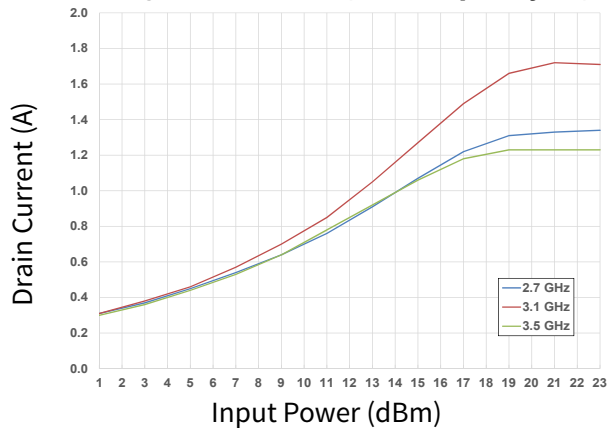
**Figure 14. Power Added Eff. vs Input Power as a Function of Frequency**



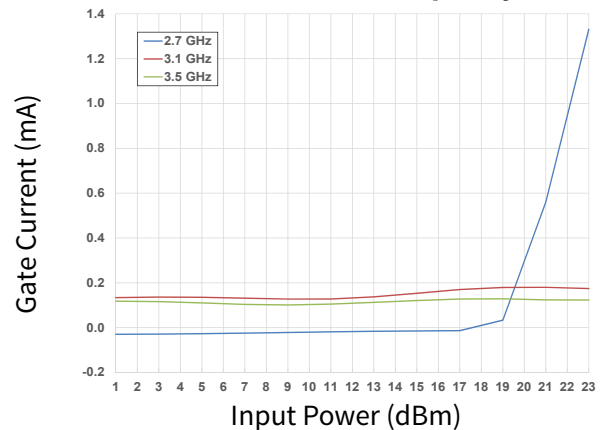
**Figure 15. Large Signal Gain vs Input Power as a Function of Frequency**



**Figure 16. Drain Current vs Input Power as a Function of Frequency**



**Figure 17. Gate Current vs Input Power as a Function of Frequency**

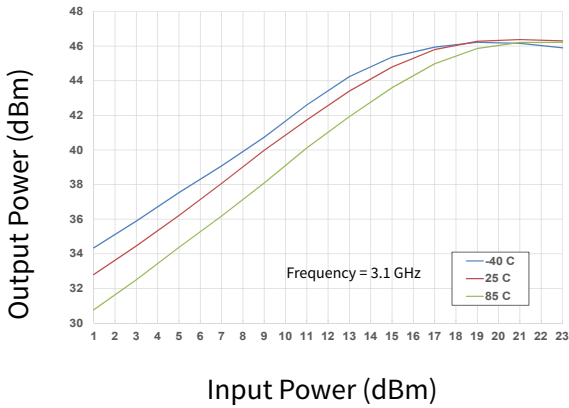




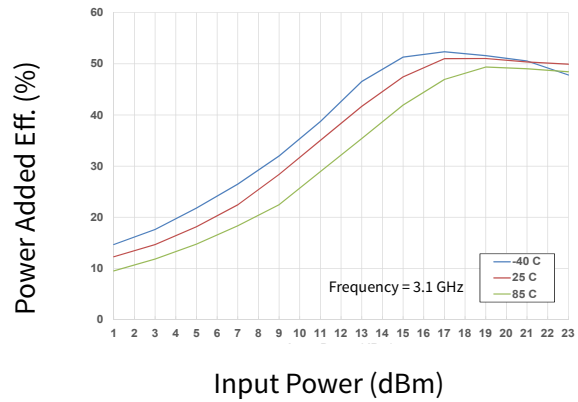
### Typical Performance of the CMPA2735030S

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $PW = 100\ \mu\text{s}$ ,  $DC = 10\%$ ,  $P_{in} = 18\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

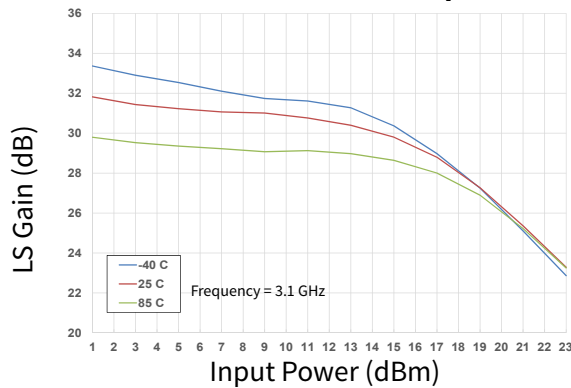
**Figure 18. Output Power vs Input Power as a Function of Temperature**



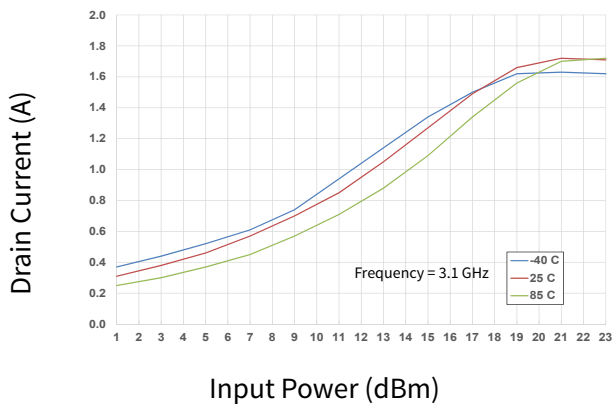
**Figure 19. Power Added Eff. vs Input Power as a Function of Temperature**



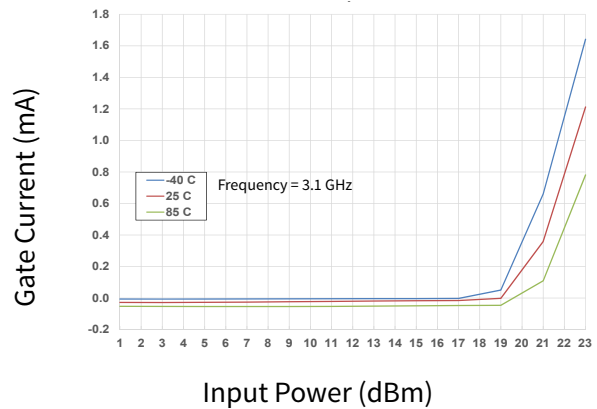
**Figure 20. Large Signal Gain vs Input Power as a Function of Temperature**



**Figure 21. Drain Current vs Input Power as a Function of Temperature**



**Figure 22. Gate Current vs Input Power as a Function of Temperature**

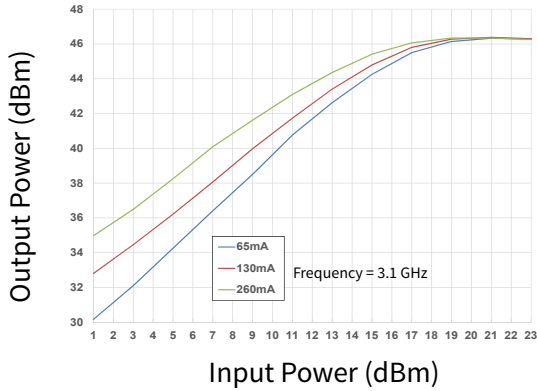




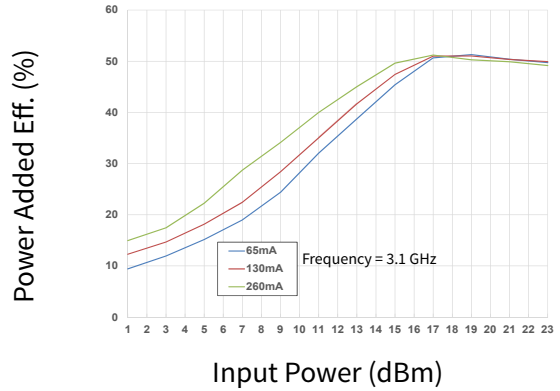
### Typical Performance of the CMPA2735030S

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $PW = 100\text{ }\mu\text{s}$ ,  $DC = 10\%$ ,  $P_{in} = 18\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

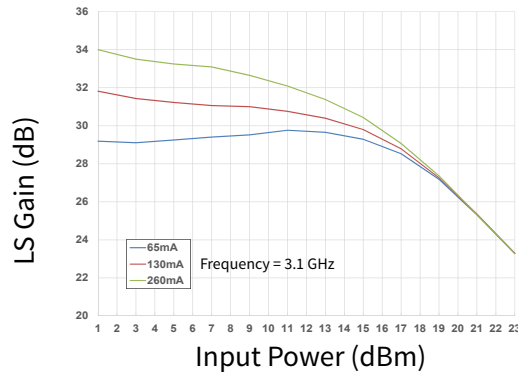
**Figure 23. Output Power vs Input Power as a Function of IDQ**



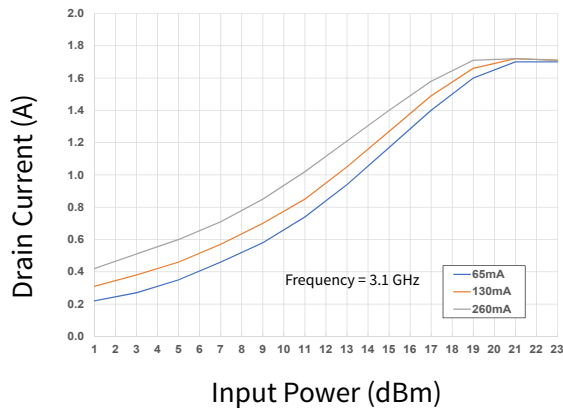
**Figure 24. Power Added Eff. vs Input Power as a Function of IDQ**



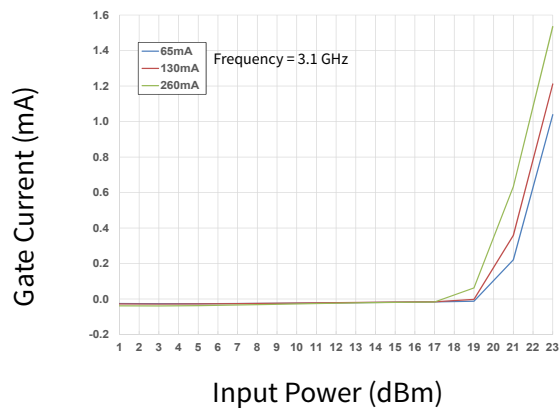
**Figure 25. Large Signal Gain vs Input Power as a Function of IDQ**



**Figure 26. Drain Current vs Input Power as a Function of IDQ**



**Figure 27. Gate Current vs Input Power as a Function of IDQ**

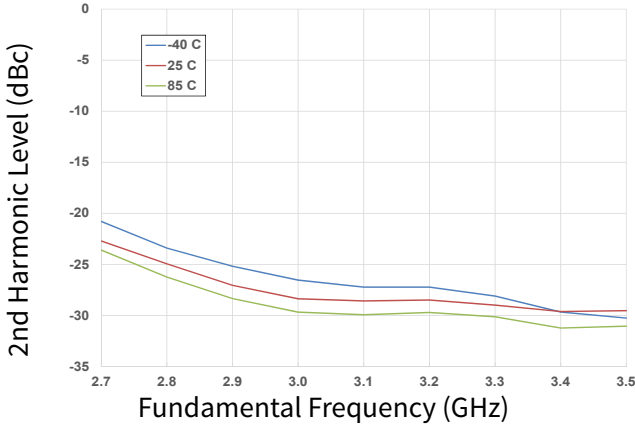




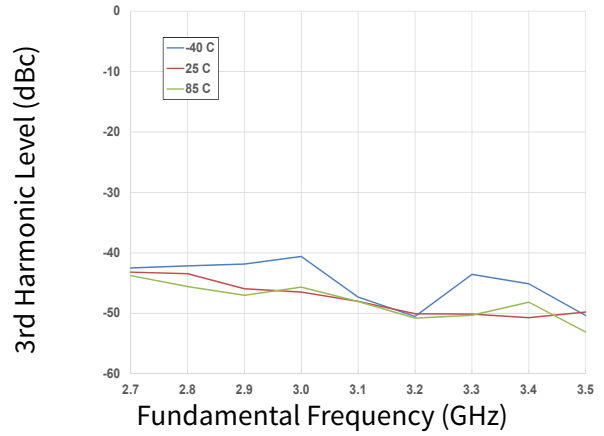
**Typical Performance of the CMPA2735030S**

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $PW = 100\text{ }\mu\text{s}$ ,  $DC = 10\%$ ,  $P_{in} = 18\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

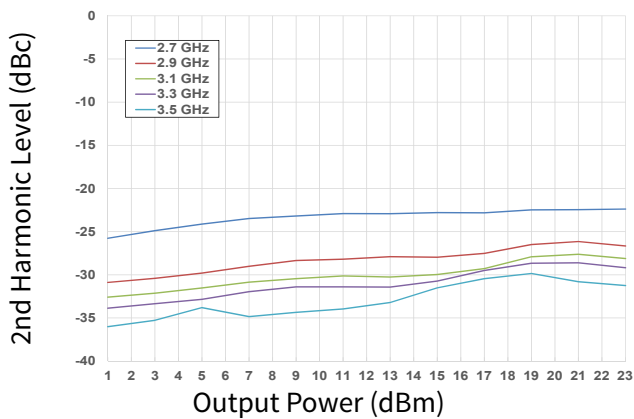
**Figure 28. 2nd Harmonic vs Frequency as a Function of Temperature**



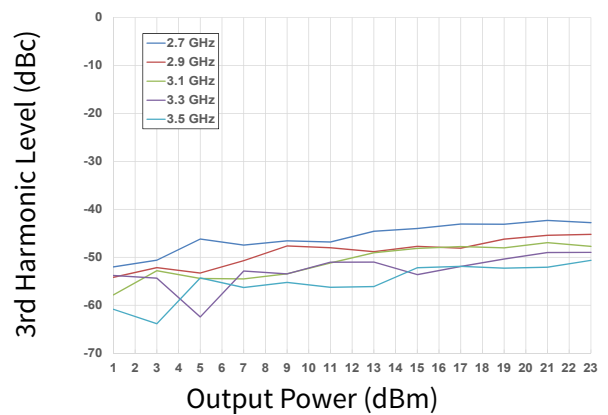
**Figure 29. 3rd Harmonic vs Frequency as a Function of Temperature**



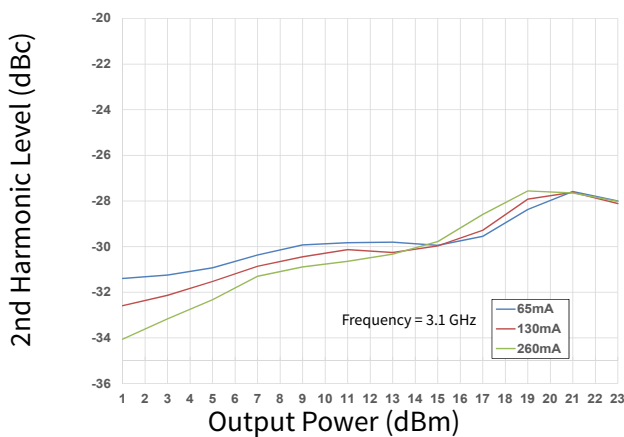
**Figure 30. 2nd Harmonic vs Input Power as a Function of Frequency**



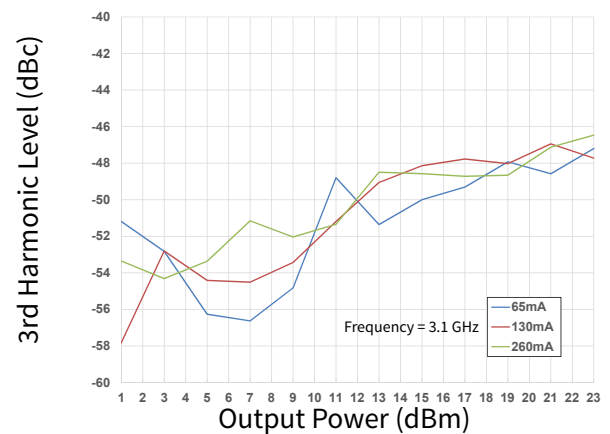
**Figure 31. 3rd Harmonic vs Input Power as a Function of Frequency**



**Figure 32. 2nd Harmonic vs Output Power as a Function of IDQ**



**Figure 33. 3rd Harmonic vs Output Power as a Function of IDQ**



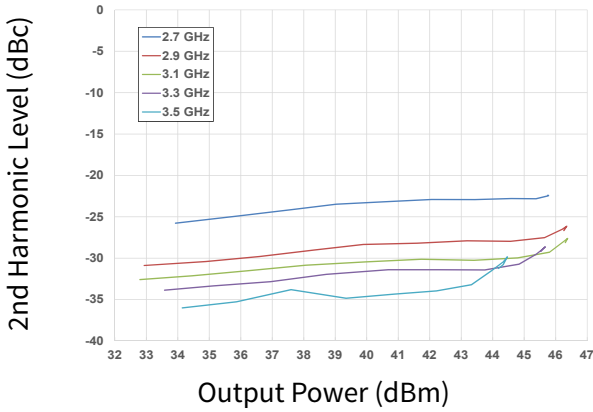




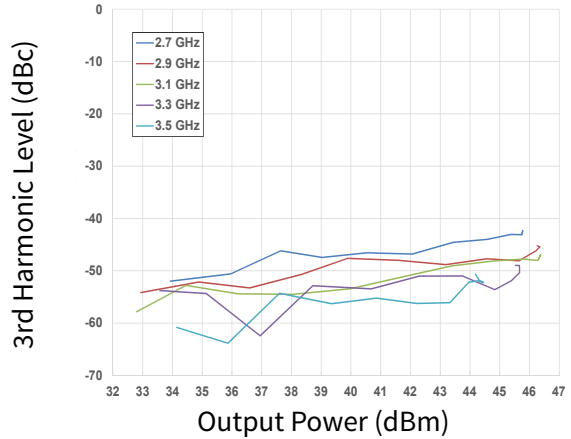
### Typical Performance of the CMPA2735030S

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $P_{in} = -20\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

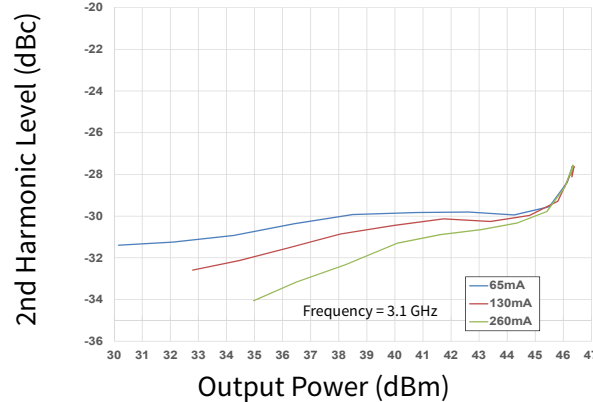
**Figure 34. 2nd Harmonic vs Output Power as a Function of Frequency**



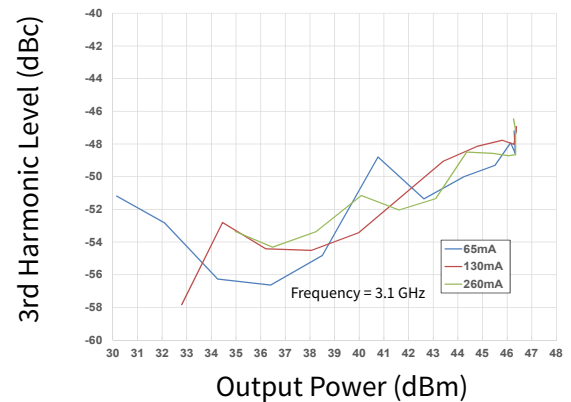
**Figure 35. 3rd Harmonic vs Output Power as a Function of Frequency**



**Figure 36. 2nd Harmonic vs Output Power as a Function of IDQ**



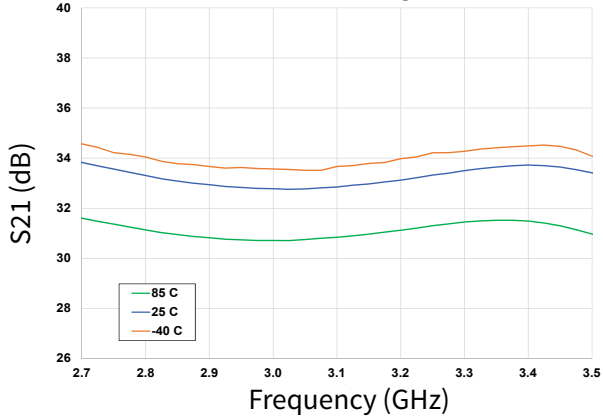
**Figure 37. 3rd Harmonic vs Output Power as a Function of IDQ**



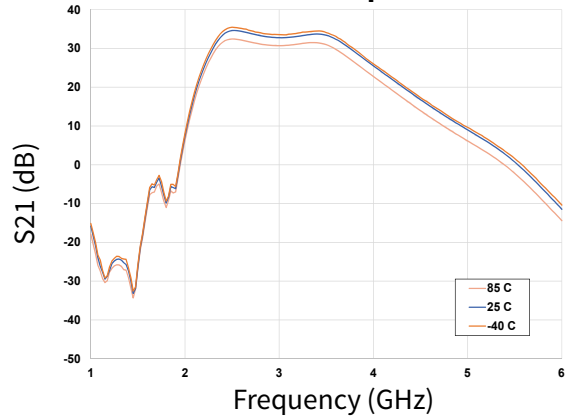
**Typical Performance of the CMPA2735030S**

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $P_{in} = -20\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

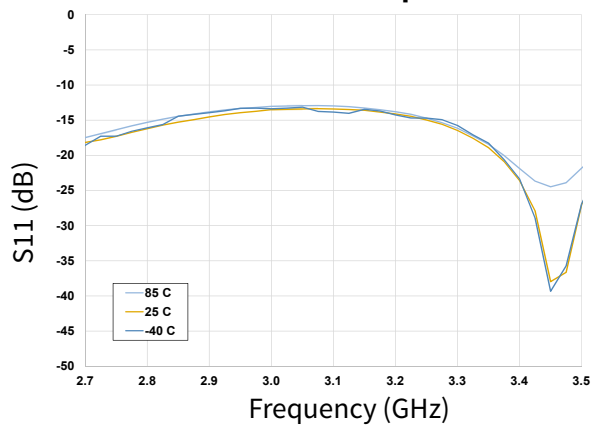
**Figure 38. Gain vs Frequency as a Function of Temperature**



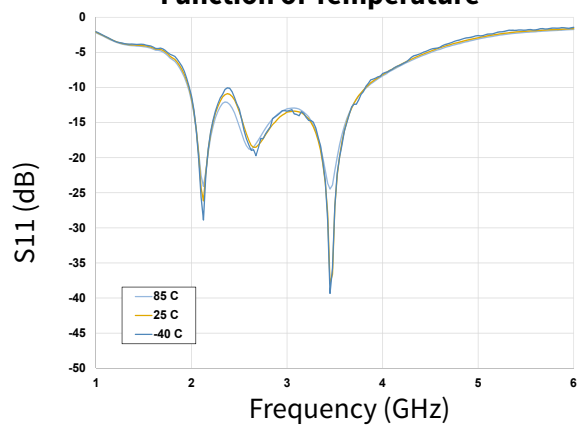
**Figure 39. Gain vs Frequency as a Function of Temperature**



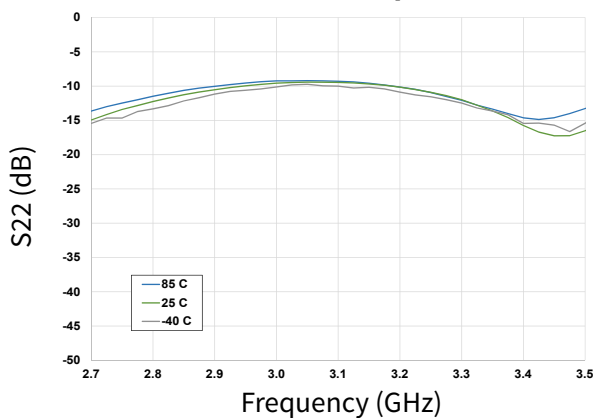
**Figure 40. Input RL vs Frequency as a Function of Temperature**



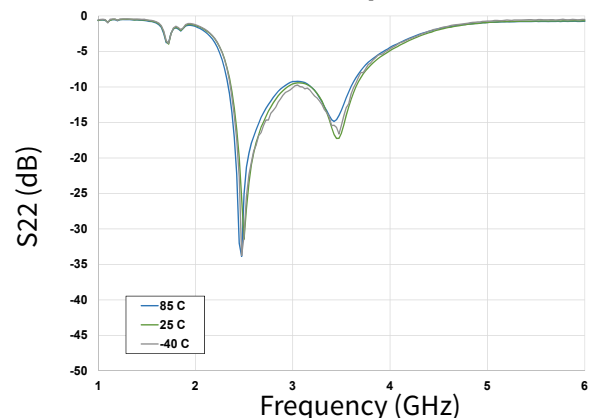
**Figure 41. Input RL vs Frequency as a Function of Temperature**



**Figure 42. Output RL vs Frequency as a Function of Temperature**



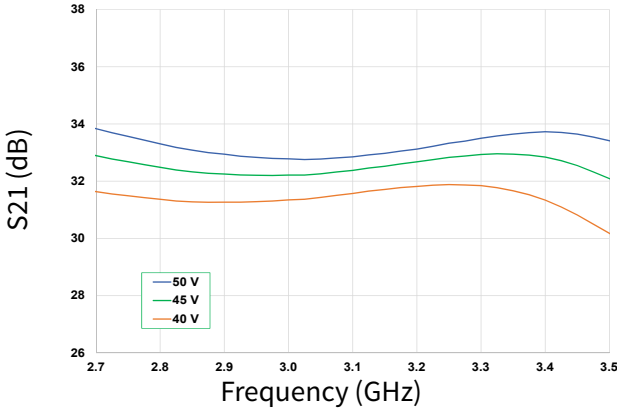
**Figure 43. Output RL vs Frequency as a Function of Temperature**



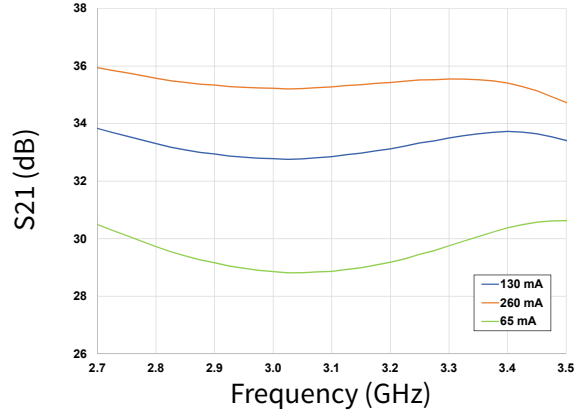
**Typical Performance of the CMPA2735030S**

Test conditions unless otherwise noted:  $V_D = 50\text{ V}$ ,  $I_{DQ} = 130\text{ mA}$ ,  $P_{in} = -20\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

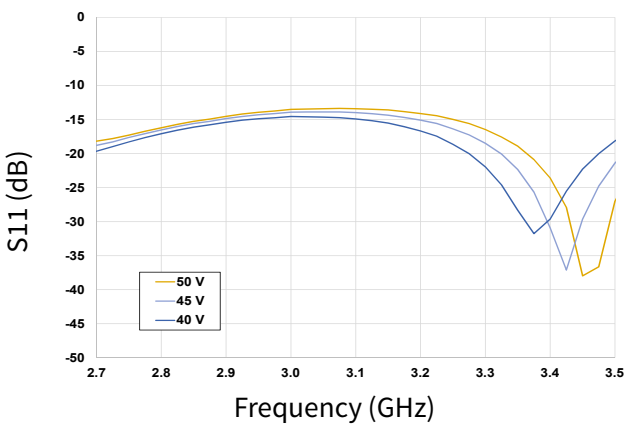
**Figure 44. Gain vs Frequency as a Function of Voltage**



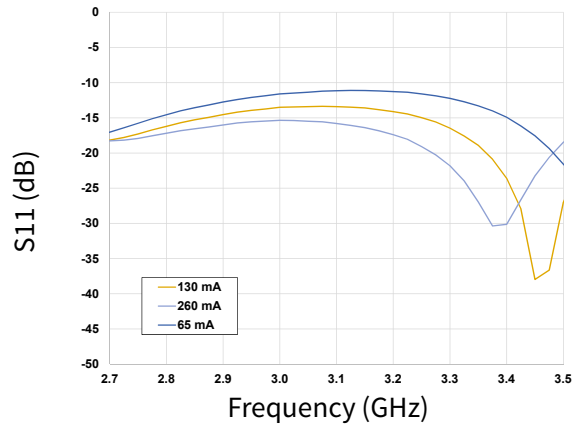
**Figure 45. Gain vs Frequency as a Function of IDQ**



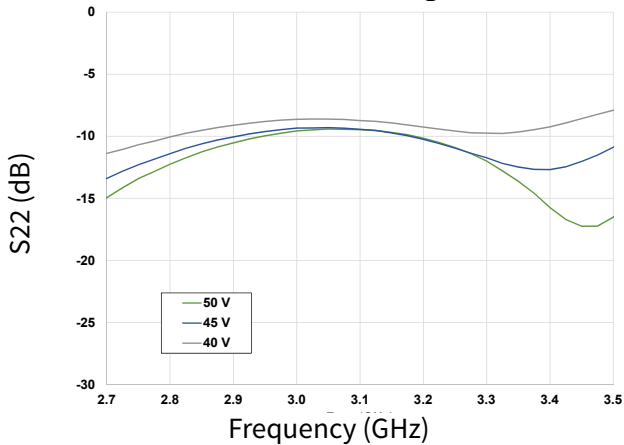
**Figure 46. Input RL vs Frequency as a Function Voltage**



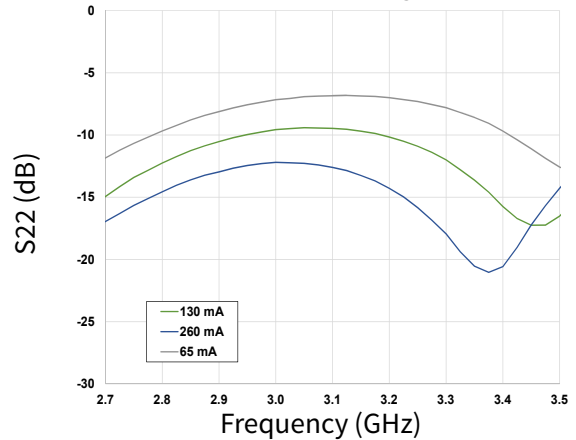
**Figure 47. Input RL vs Frequency as a Function of IDQ**



**Figure 48. Output RL vs Frequency as a Function of Voltage**



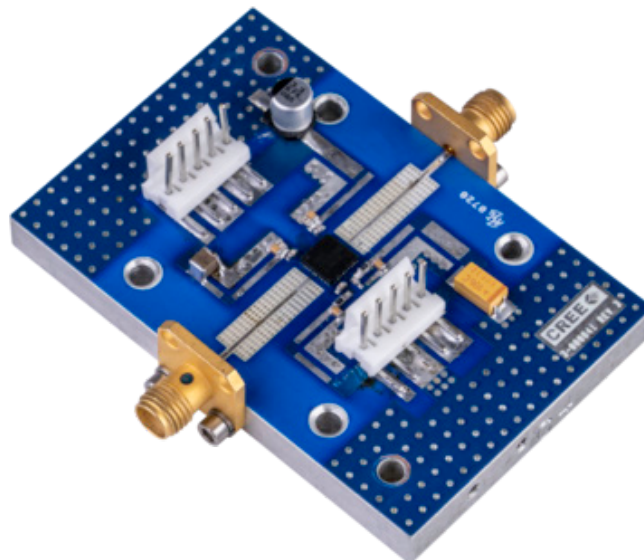
**Figure 49. Output RL vs Frequency as a Function of IDQ**



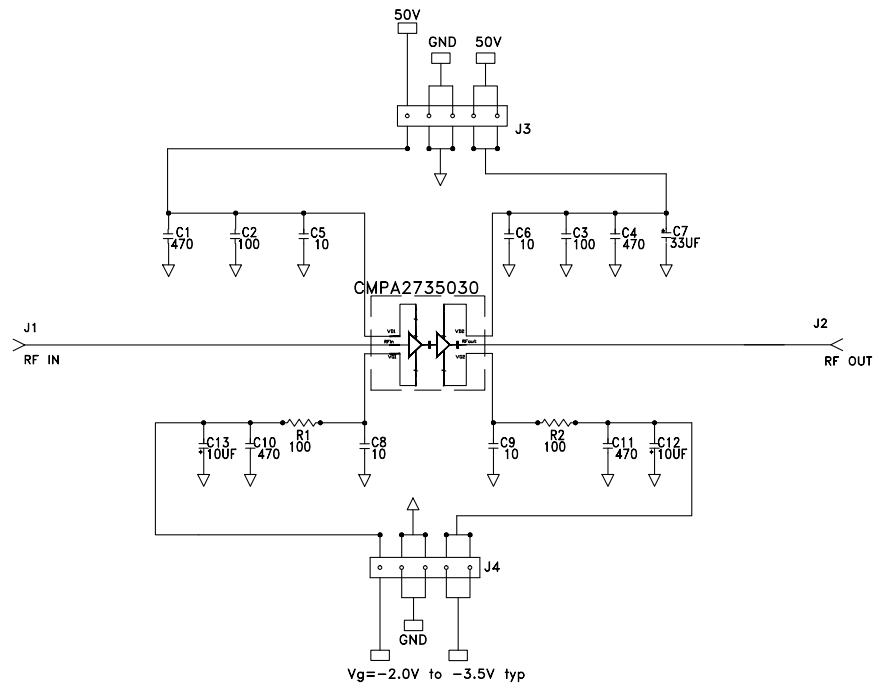
**CMPA2735030S-AMP1 Evaluation Board Bill of Materials**

Designator	Description	Qty
C1, C4, C10, C11	CAP, 470pF, 100V, 0603	4
C2, C3	CAP, 100pF, 100V, 0603	2
C5, C6, C8, C9	CAP, 10pF, 100V, 0402	4
C7	CAP, 33uF, 50V, ELECT, MVY, SMD	1
C12,C13	CAP, 10uF, 16V, TANTALUM, SMD	2
R1, R2	RES, 100Ohm, 1/16W, 0603	2
J1, J2	CONNECTOR, N-TYPE, FEMALE, W/0.500 SMA FLNG	2
J3, J4	CONNECTOR, HEADER, RT>PLZ .1CEN LK 5POS	2
-	PCB, RO4350B, E <sub>r</sub> = 3.48, h = 10 mil	1
Q1	CMPA2735030S	1

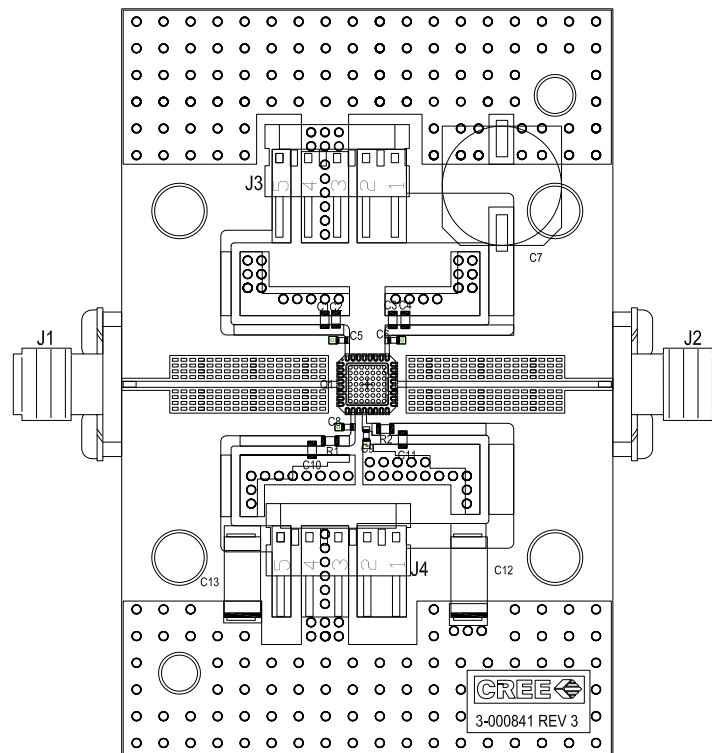
**CMPA2735030S-AMP1 Evaluation Board**



**CMPA2735030S-AMP1 Application Circuit**



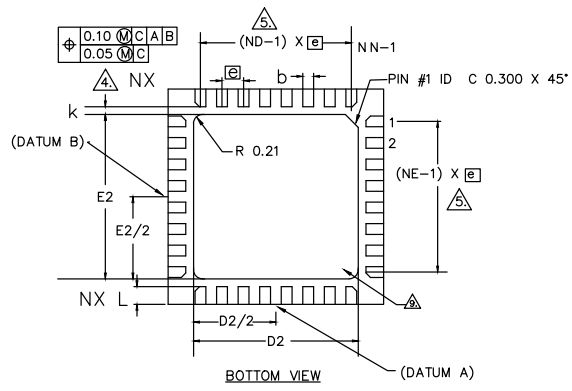
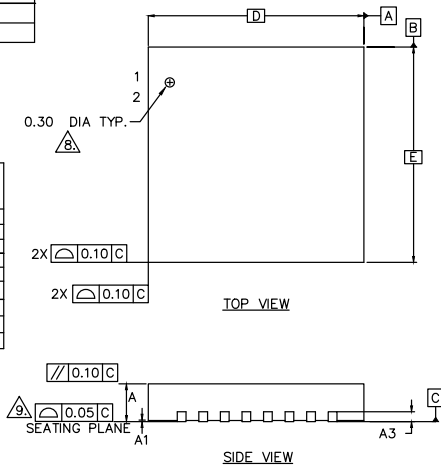
**CMPA2735030S-AMP1 Evaluation Board Layout**



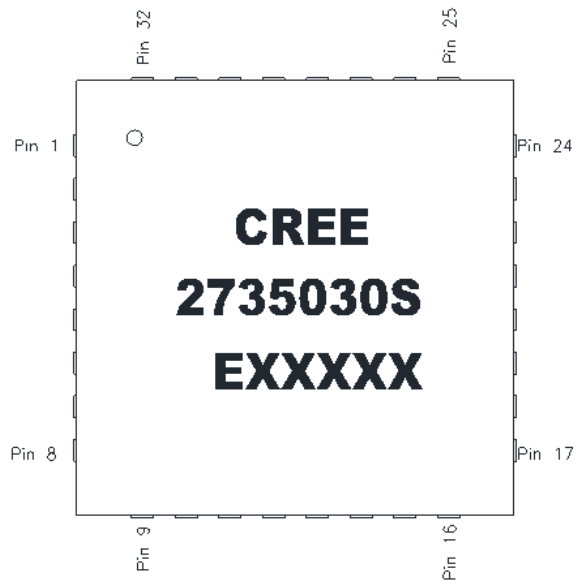
**Product Dimensions CMPA2735030S (Package)**

SYMBOL	MIN. NOM. MAX.			NOTE
	A	0.80	0.86	
A1	0.00	0.03	0.06	
A3	0.20 REF			
Ø	0		12	2
K	0.17 MIN.			
D	5.0 BSC			
E	5.0 BSC			

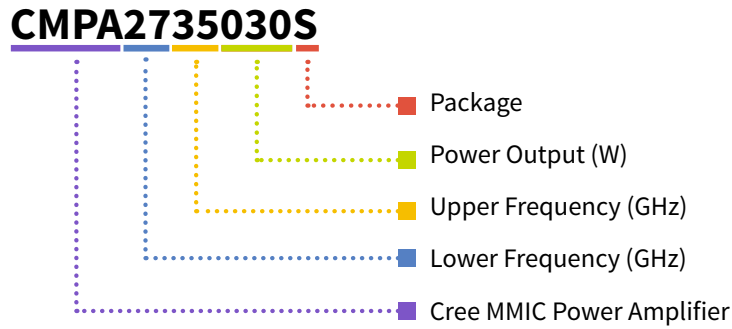
SYMBOL	0.50mm LEAD PITCH			NOTE
	Ø	MIN.	NOM.	
N	32			3
ND	8			4
NE	8			5
L	0.35	0.41	0.46	
b	0.21	0.25	0.29	6
D2	3.76	3.82	3.88	
E2	3.76	3.82	3.88	



PIN	DESC.	PIN	DESC.	PIN	DESC.
1	NC	15	NC	29	NC
2	NC	16	NC	30	NC
3	NC	17	NC	31	NC
4	RFIN	18	NC	32	VD1
5	RFIN	19	NC		
6	NC	20	RFOUT		
7	NC	21	RFOUT		
8	NC	22	NC		
9	NC	23	NC		
10	VG1	24	NC		
11	VG2	25	VD2		
12	NC	26	NC		
13	NC	27	NC		
14	NC	28	NC		



**Part Number System**



**Table 1.**

Parameter	Value	Units
Lower Frequency	2.7	GHz
Upper Frequency	3.5	GHz
Power Output	30	W
Package	Surface Mount	-

**Note:** Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

**Table 2.**

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz



**Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CMPA2735030S	GaN HEMT	Each	
CMPA2735030S-AMP1	Test board with GaN MMIC installed	Each	